

## UNISONIC TECHNOLOGIES CO., LTD

UF50N06-Q

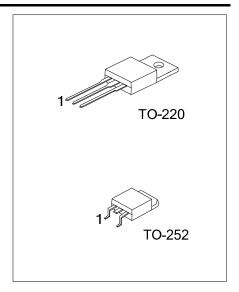
**Preliminary** 

**Power MOSFET** 

# 50A, 60V N-CHANNEL POWER MOSFET

#### **■** DESCRIPTION

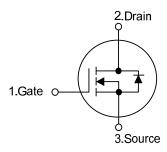
The UTC **UF50N06-Q** is a high voltage power MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.



#### **■ FEATURES**

- \*  $R_{DS(ON)}$  < 25m $\Omega$  @  $V_{GS}$ =10V,  $I_D$ =25A
- \* High switching speed
- \* 100% avalanche tested

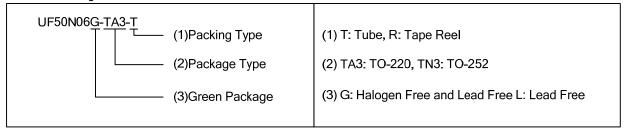
#### ■ SYMBOL



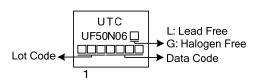
#### ■ ORDERING INFORMATION

Ordering Number		Dookogo	Pin	Assignm	Dooking		
Lead Free	Halogen Free	Package	1	2	3	Packing	
UF50N06L-TA3-T	UF50N06G-TA3-T	TO-220	G	D	S	Tube	
UF50N06L-TN3-R	UF50N06G-TN3-R	TO-252	G	D	S	Tape Reel	

Note: Pin Assignment: G: Gate D: Drain S: Source



## ■ MARKING



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## ■ **ABSOLUTE MAXIMUM RATINGS** (T<sub>A</sub> =25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		$V_{ extsf{DSS}}$	60	V	
Gate-Source Voltage		$V_{GSS}$	±25	V	
Continuous Drain Current	Continuous	I <sub>D</sub>	50	Α	
	Pulsed	I <sub>DM</sub>	200	Α	
Avalanche Energy		E <sub>AS</sub>	287	mJ	
Peak Diode Recovery dv/dt (Note 4)		dv/dt	12.6	V/ns	
Power Dissipation	TO-220	D	80	mW	
	TO-252	$P_{D}$	50	mW	
Junction Temperature		$T_J$	+150	°C	
Storage Temperature Range		T <sub>STG</sub>	-55 ~ +150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L=0.38mH,  $I_{AS}$ =38A,  $V_{DD}$ =50V,  $R_{G}$ =25  $\Omega$ , Starting  $T_{J}$  = 25°C
- 4.  $I_{SD} \le 50A$ , di/dt  $\le 250A/\mu s$ ,  $V_{DD} \le BV_{DSS}$ , Starting  $T_J = 25^{\circ}C$

#### ■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT	
lunation to Ambient	TO-220	0	62.5	°C/W	
Junction to Ambient	TO-252	θ <sub>JA</sub>	110	°C/W	
lunation to Coop	TO-220	- Өлс	1.56	°C/W	
Junction to Case	TO-252		2.5	°C/W	

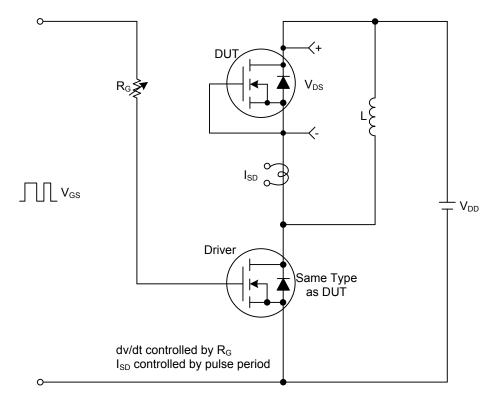
## ■ **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> =25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS		TYP	MAX	UNIT	
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage		$BV_{DSS}$	$I_D=250\mu A, V_{GS}=0V$	60			V	
Drain-Source Leakage Current		I <sub>DSS</sub>	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V			1	μΑ	
Gate-Source Leakage Current	Forward	- I <sub>GSS</sub>	V <sub>GS</sub> =+20V, V <sub>DS</sub> =0V			10	μΑ	
	Reverse		V <sub>GS</sub> =-20V, V <sub>DS</sub> =0V			-10	μΑ	
ON CHARACTERISTICS								
Gate Threshold Voltage		$V_{GS(TH)}$	$I_D=250\mu A, V_{DS}=V_{GS}$	2.0		4.0	V	
Static Drain-Source On-State Resistance		R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =25A			25	mΩ	
DYNAMIC PARAMETERS								
Input Capacitance		C <sub>ISS</sub>			1800		pF	
Output Capacitance		Coss	V <sub>GS</sub> =0V, V <sub>DS</sub> =25V, f=1MHz		390		pF	
Reverse Transfer Capacitance		$C_{RSS}$			64		pF	
SWITCHING PARAMETERS								
Total Gate Charge (Note 1)		$Q_G$	V <sub>GS</sub> =10V, V <sub>DS</sub> =50V, I <sub>D</sub> =1.3A		63.6		nC	
Gate to Source Charge		$Q_{GS}$	$I_{G}$ =100 $\mu$ A (Note 1, 2)		9.2		nC	
Gate to Drain Charge		$Q_GD$	IG-100µA (Note 1, 2)		12		nC	
Turn-ON Delay Time (Note 1)		$t_{D(ON)}$			78		ns	
Rise Time		$t_R$	$V_{GS}$ =10V, $V_{DD}$ =30V, $R_{G}$ =25 $\Omega$ ,		81		ns	
Turn-OFF Delay Time		$t_{D(OFF)}$	I <sub>D</sub> =0.5A (Note 1, 2)		340		ns	
Fall-Time		$t_{F}$			162		ns	
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS								
Maximum Body-Diode Continuous Current		I <sub>S</sub>				50	Α	
Maximum Body-Diode Pulsed Current		$I_{SM}$				200	Α	
Drain-Source Diode Forward Voltage (Note 1)		$V_{SD}$	I <sub>S</sub> =20A, V <sub>GS</sub> =0V			1.4	V	
Body Diode Reverse Recovery Time (Note 1)		t <sub>rr</sub>	I <sub>S</sub> =40A, V <sub>GS</sub> =0V		66		ns	
Body Diode Reverse Recovery Charge		$Q_{rr}$	$dI_F/dt = 100A/\mu s$		0.5		μC	

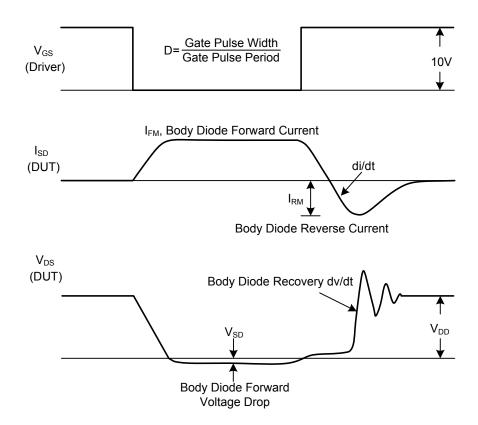
Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%.

<sup>2.</sup> Essentially independent of operating temperature.

## **■ TEST CIRCUITS AND WAVEFORMS**

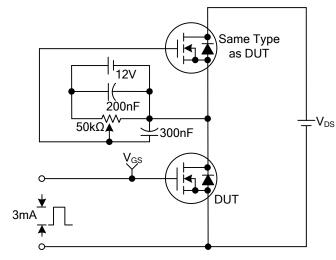


Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

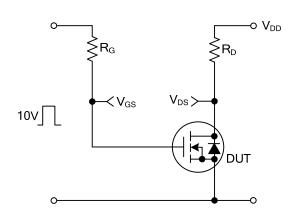
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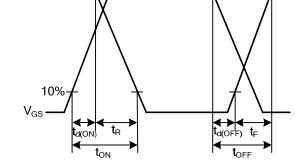


 $Q_{\rm GS}$   $Q_{\rm GD}$   $Q_{\rm GD}$   $Q_{\rm GD}$ 

Gate Charge Test Circuit

Gate Charge Waveforms

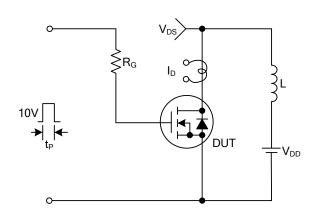


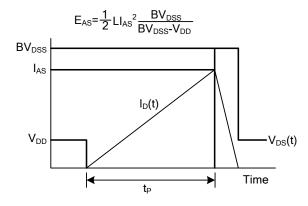


90%

Resistive Switching Test Circuit

Resistive Switching Waveforms





Unclamped Inductive Switching Test Circuit

**Unclamped Inductive Switching Waveforms** 

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